

MOSFET

OptiMOS™ 6 Power-Transistor, 120 V

Features

- N-channel, normal level
- Very low on-resistance R_{DS(on)}
 Excellent gate charge x R_{DS(on)} product (FOM)
 Very low reverse recovery charge (Q_{rr})
- · High avalanche energy rating
- 175°C operating temperature
- Optimized for high frequency switching
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21
- MSL 1 classified according to J-STD-020

Product validation

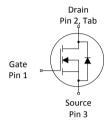
Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

| Parameter | Value | Unit |
|-----------------------------|-------|------|
| V_{DS} | 120 | V |
| R _{DS(on),max} | 13.3 | mΩ |
| I_{D} | 55 | А |
| $Q_{\rm oss}$ | 36 | nC |
| Q_{G} | 15 | nC |
| Q _{rr} (1000 A/μs) | 180 | nC |









| Type/Ordering Code | Package | Marking | Related Links |
|--------------------|------------|----------|---------------|
| IPB133N12NM6 | PG-T0263-3 | 133N12N6 | - |

Public

OptiMOS™ 6 Power-Transistor, 120 V IPB133N12NM6



Table of Contents

| Description | 1 |
|-------------------------------------|------|
| Maximum ratings | 3 |
| Thermal characteristics | 3 |
| Electrical characteristics | 4 |
| Electrical characteristics diagrams | 6 |
| Package Outlines | . 10 |
| Revision History | . 11 |
| Trademarks | . 11 |
| Disclaimer | 11 |

OptiMOS™ 6 Power-Transistor, 120 V IPB133N12NM6



1 Maximum ratings

unless otherwise specified

Table 2 Maximum ratings

| Parameter | Symbol | Values | | | Unit | Note / Took Condition |
|--|-------------------------|--------|------|----------------------|-------|---|
| Parameter | Syllibol | Min. | Тур. | Мах. | Ollic | Note/ Test Condition |
| Continuous drain current ¹⁾ | I _D | - | - | 55 41 38 12 | A | $V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =8 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10V, $T_{\rm A}$ =25°C, $R_{\rm THJA}$ =40°C/W ²⁾ |
| Pulsed drain current ³⁾ | I _{D,pulse} | - | - | 220 | А | T _A =25 °C |
| Avalanche energy, single pulse ⁴⁾ | E _{AS} | - | - | 73 | mJ | I_D =22 A, R_{GS} =25 Ω |
| Gate source voltage | V_{GS} | -20 | - | 20 | V | - |
| Power dissipation | P _{tot} | - | - | 94 3.8 | W | $T_{\rm C}$ =25 °C $T_{\rm A}$ =25 °C, $R_{\rm thJA}$ =40 °C/W ²⁾ |
| Operating and storage temperature | $T_{\rm j},T_{\rm stg}$ | -55 | - | 175 | °C | - |

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

2 Thermal characteristics

Table 3 Thermal characteristics

| Doromotor | Symphol | Values | | | I In: | Note / Test Condition |
|-------------------------------------|---------------------|--------|------|------|-------|-----------------------|
| Parameter | Symbol | Min. | Тур. | Мах. | Unit | Note/ Test Condition |
| Thermal resistance, junction - case | R_{thJC} | - | - | 1.6 | °C/W | - |
| Thermal resistance, junction - | | | | | | |
| ambient, | R_{thJA} | - | - | 40 | °C/W | - |
| 6 cm² cooling area ⁵⁾ | | | | | | |

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain connection. PCB is vertical in still air.

Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm 2 (one layer, 70 μ m thick) copper area for drain connection. PCB is vertical in still air.

³⁾ See Diagram 3 for more detailed information.

⁴⁾ See Diagram 13 for more detailed information.

OptiMOS™ 6 Power-Transistor, 120 V IPB133N12NM6



3 Electrical characteristics

unless otherwise specified

Table 4 Static characteristics

| Parameter | Symbol | | Values | | | Note / Test Condition |
|----------------------------------|-----------------------|------|------------|--------------|------|---|
| raiailletei | Syllibot | Min. | Тур. | Мах. | Unit | Note/ Test Condition |
| Drain-source breakdown voltage | V _{(BR)DSS} | 120 | - | - | V | V _{GS} =0 V, I _D =1 mA |
| Gate threshold voltage | $V_{\rm GS(th)}$ | 2.6 | 3.1 | 3.6 | V | $V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 35 \mu \text{A}$ |
| Zero gate voltage drain current | I _{DSS} | - | 0.1 10 | 1 100 | μΑ | $V_{\rm DS}$ =100 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =25 °C $V_{\rm DS}$ =100 V, $V_{\rm GS}$ =0 V, $T_{\rm j}$ =125 °C |
| Gate-source leakage current | I _{GSS} | - | 10 | 100 | nA | V _{GS} =20 V, V _{DS} =0 V |
| Drain-source on-state resistance | $R_{\mathrm{DS(on)}}$ | - | 12.3 14 | 13.3 15.8 | mΩ | V_{GS} =10 V, I_{D} =22 A V_{GS} =8 V, I_{D} =11 A |
| Gate resistance | R_{G} | 0.46 | 0.91 | 1.37 | Ω | - |
| Transconductance | g_{fs} | 16.5 | 33 | - | S | $ V_{\rm DS} \ge 2 I_{\rm D} R_{\rm DS(on)max}, I_{\rm D} = 22 \text{ A}$ |

Table 5 Dynamic characteristics

| Parameter | Symbol | Values | | | Unit | Note / Test Condition | |
|--|-------------------|--------|------|------|------|--|--|
| - rarameter | meter Symbol Min. | | Тур. | Max. | Unit | Note/ Test Condition | |
| Input capacitance | C _{iss} | - | 1100 | 1400 | pF | V _{GS} =0 V, V _{DS} =60 V, <i>f</i> =1 MHz | |
| Output capacitance ⁶⁾ | C _{oss} | - | 320 | 420 | pF | $V_{\rm GS}$ =0 V, $V_{\rm DS}$ =60 V, f =1 MHz | |
| Reverse transfer capacitance ⁶⁾ | C _{rss} | - | 10 | 18 | pF | V _{GS} =0 V, V _{DS} =60 V, <i>f</i> =1 MHz | |
| Turn-on delay time | $t_{\sf d(on)}$ | - | 8.8 | - | ns | $V_{\rm DD}$ =60 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =11 A, $R_{\rm G,ext}$ =1. 6 Ω | |
| Rise time | t _r | - | 3.5 | - | ns | $V_{\rm DD}$ =60 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =11 A, $R_{\rm G,ext}$ =1. | |
| Turn-off delay time | $t_{ m d(off)}$ | - | 12 | - | ns | $V_{\rm DD}$ =60 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =11 A, $R_{\rm G,ext}$ =1. | |
| Fall time | t_{f} | - | 16 | - | ns | $V_{\rm DD}$ =60 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =11 A, $R_{\rm G,ext}$ =1. | |

⁶⁾ Defined by design. Not subject to production test.

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Table 6 Gate charge characteristics 7)

| Parameter | Symbol | Values | | | Unit | Note / Test Condition |
|--|----------------------|--------|------|------|-------|--|
| | Syllibot | Min. | Тур. | Мах. | Oilit | Note/ Test Condition |
| Gate to source charge ⁸⁾ | $Q_{ m gs}$ | - | 5.4 | 7 | nC | $V_{\rm DD}$ =60 V, $I_{\rm D}$ =11 A, $V_{\rm GS}$ =0 to 10 V |
| Gate charge at threshold ⁸⁾ | $Q_{\mathrm{g(th)}}$ | - | 3.3 | 4.1 | nC | $V_{\rm DD}$ =60 V, $I_{\rm D}$ =11 A, $V_{\rm GS}$ =0 to 10 V |
| Gate to drain charge ⁸⁾ | $Q_{ m gd}$ | - | 3.5 | 5.3 | nC | $V_{\rm DD}$ =60 V, $I_{\rm D}$ =11 A, $V_{\rm GS}$ =0 to 10 V |
| Switching charge | Q_{sw} | - | 5.6 | - | nC | $V_{\rm DD}$ =60 V, $I_{\rm D}$ =11 A, $V_{\rm GS}$ =0 to 10 V |
| Gate charge total ⁸⁾ | Q_{g} | - | 15 | 19 | nC | $V_{\rm DD}$ =60 V, $I_{\rm D}$ =11 A, $V_{\rm GS}$ =0 to 10 V |
| Gate plateau voltage | $V_{ m plateau}$ | - | 5.1 | - | V | $V_{\rm DD}$ =60 V, $I_{\rm D}$ =11 A, $V_{\rm GS}$ =0 to 10 V |
| Output charge ⁸⁾ | $Q_{ m oss}$ | - | 36 | 47 | nC | V _{DS} =60 V, V _{GS} =0 V |

 $^{^{7)} \;\;}$ See "Gate charge waveforms" for parameter definition

Table 7 Reverse diode

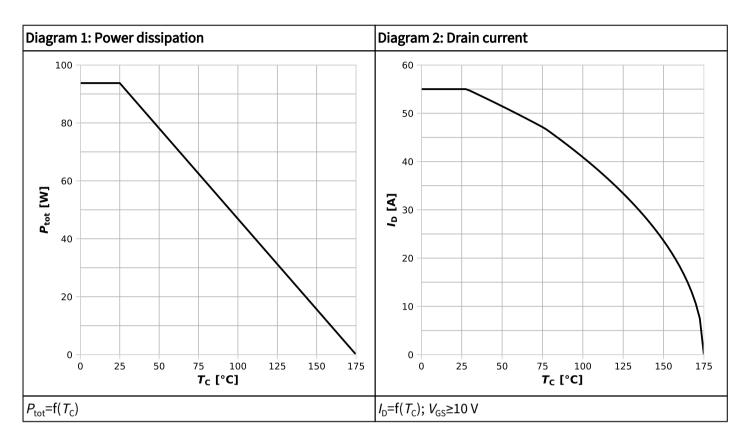
| Parameter | Symbol | Values | | | Unit | Note / Took Condition | |
|---------------------------------------|----------------------|--------|------|------|-------|---|--|
| raiailletei | Symbol | Min. | Тур. | Мах. | Offic | Note/ Test Condition | |
| Diode continuous forward current | Is | - | - | 55 | А | <i>T</i> _C =25 °C | |
| Diode pulse current | I _{S,pulse} | - | - | 220 | А | <i>T</i> _C =25 °C | |
| Diode forward voltage | $V_{\rm SD}$ | - | 0.88 | 1 | V | $V_{\rm GS}$ =0 V, $I_{\rm F}$ =22 A, $T_{\rm j}$ =25 °C | |
| Reverse recovery time ⁹⁾ | t _{rr} | - | 33 | 66 | ns | $V_{\rm R}$ =60 V, $I_{\rm F}$ =11 A, d $i_{\rm F}$ /d t =300 A/ μ s | |
| Reverse recovery charge ⁹⁾ | $Q_{\rm rr}$ | - | 52 | 104 | nC | $V_{\rm R}$ =60 V, $I_{\rm F}$ =11 A, d $i_{\rm F}$ /d t =300 A/ μ s | |
| Reverse recovery time ⁹⁾ | t _{rr} | - | 24 | 48 | ns | $V_{\rm R}$ =60 V, $I_{\rm F}$ =11 A, d $i_{\rm F}$ /d t =1000 A/ μ s | |
| Reverse recovery charge ⁹⁾ | $Q_{\rm rr}$ | - | 180 | 360 | nC | $V_{\rm R}$ =60 V, $I_{\rm F}$ =11 A, d $i_{\rm F}$ /d t =1000 A/ μ s | |

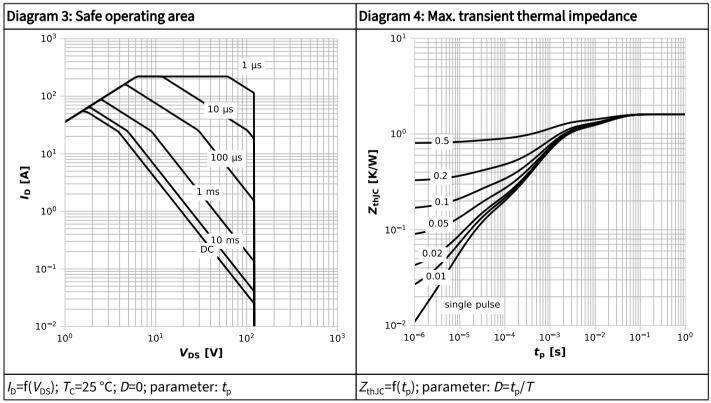
⁹⁾ Defined by design. Not subject to production test.

⁸⁾ Defined by design. Not subject to production test.

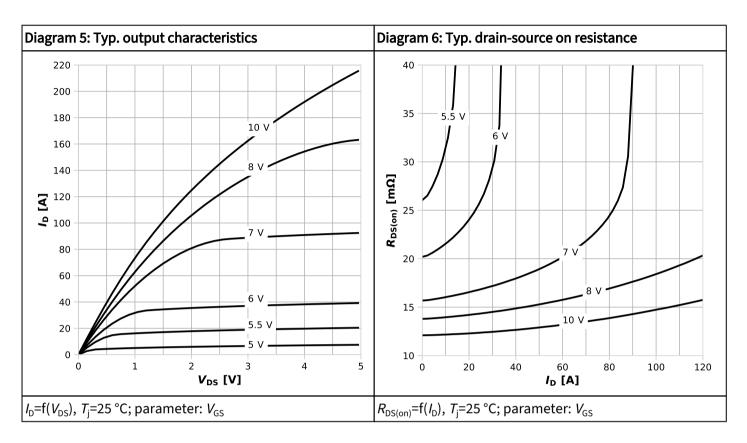


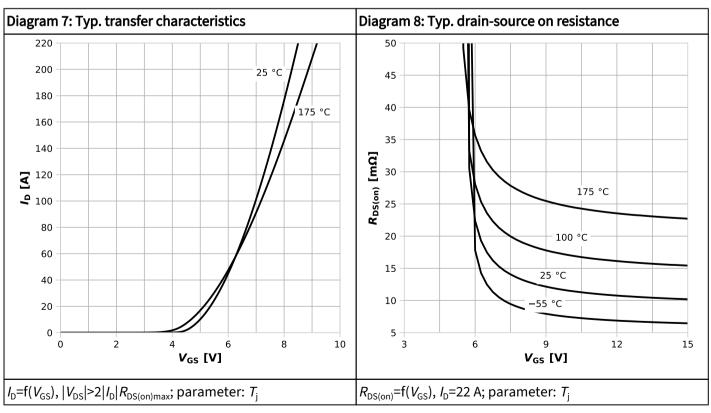
4 Electrical characteristics diagrams



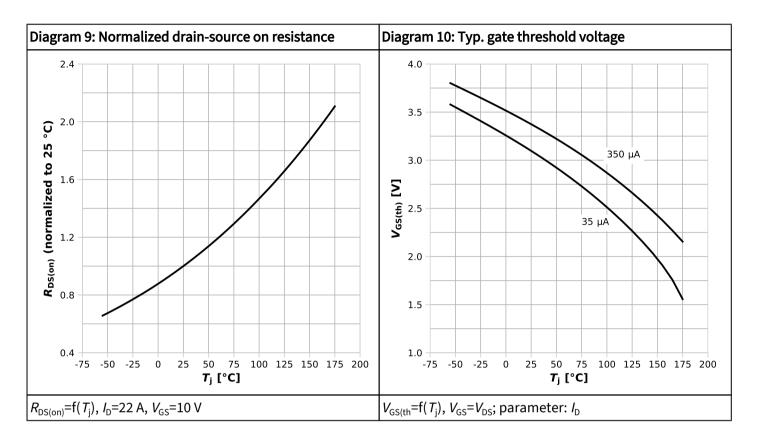


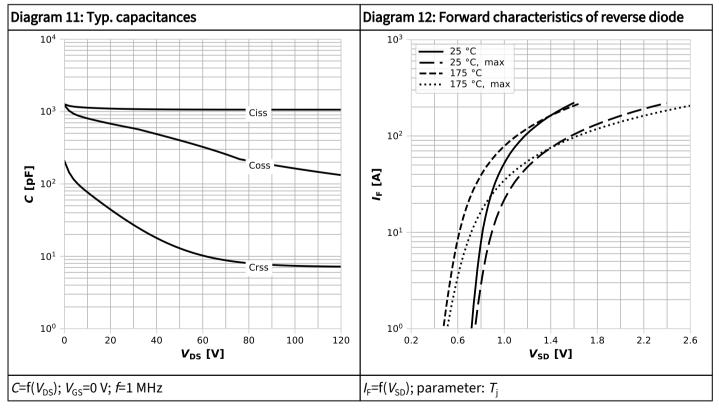




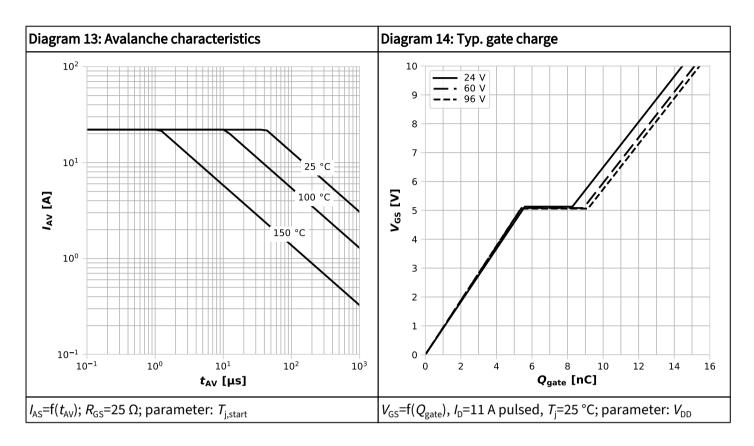


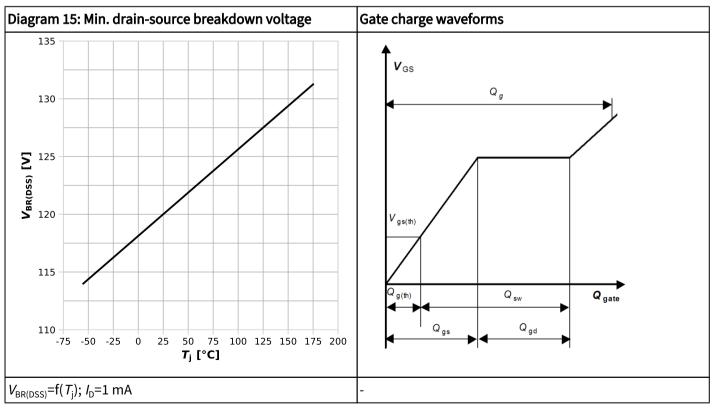






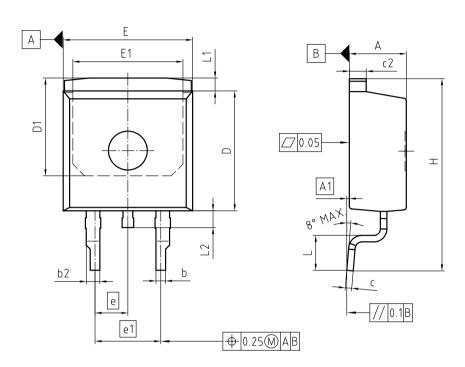








5 Package Outlines



| PACKAGE - GROUP NUMBER: | PG-TO20 | PG-TO263-3-U01 | | | | | |
|----------------------------|-------------|----------------|--|--|--|--|--|
| DIMENSIONS | MILLIMETERS | | | | | | |
| DIMENSIONS | MIN. | MAX. | | | | | |
| Α | 4.30 | 4.50 | | | | | |
| A1 | 0.00 | 0.10 | | | | | |
| b | 0.65 | 0.85 | | | | | |
| b2 | 0.95 | 1.15 | | | | | |
| С | 0.40 | 0.60 | | | | | |
| c2 | 1.17 | 1.37 | | | | | |
| D | 9.05 | 9.45 | | | | | |
| D1 | 7.45 | 7.65 | | | | | |
| E | 9.80 | 10.20 | | | | | |
| E1 | 8.40 | 8.60 | | | | | |
| е | 2. | 54 | | | | | |
| e1 | 5.08 | | | | | | |
| N | | 2 | | | | | |
| Н | 14.60 | 15.90 | | | | | |
| L | 2.40 | 3.00 | | | | | |
| L1 | 0.70 | 1.30 | | | | | |
| L2 | 1.00 | 1.60 | | | | | |

Figure 1 Outline PG-TO263-3, dimensions in mm

OptiMOS™ 6 Power-Transistor, 120 V IPB133N12NM6



Revision History

IPB133N12NM6

Revision 2024-05-16, Rev. 2.1

Previous Revision

| Revision Date Subjects (major change | | Subjects (major changes since last revision) |
|--------------------------------------|------------|--|
| 2.0 | 2024-01-15 | Release of final version |
| 2.1 | 2024-05-16 | Update Qrr |

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